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T-2S-15



查询TXN80K供应商

捷多邦, 专业PCB打样工厂

24小时加急出货

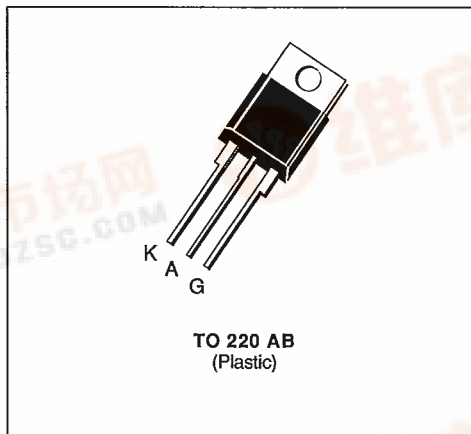
SGS-THOMSON MICROELECTRONICS

TXN/TYN 058,G,K → 1008,G,K

S G S-THOMSON

THYRISTORS

- GLASS PASSIVATED CHIP
- POSSIBILITY OF MOUNTING ON PRINTED CIRCUIT
- AVAILABLE IN NON-INSULATED VERSION → TYN SERIES OR IN INSULATED VERSION → TXN SERIES (INSULATING VOLTAGE 2500 V_{RMS})
- UL RECOGNIZED FOR TXN SERIES (E81734)



DESCRIPTION

SCR's designed for motor control, heating controls, power supplies...

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state Current (1)	$T_c = 75^\circ C$	8	A
$I_{T(AV)}$	Mean on-state Current (1)	$T_c = 75^\circ C$	5	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_j initial = $25^\circ C$) (2)	$t = 8.3$ ms	84	A
		$t = 10$ ms	80	
I^2t	I^2t Value for Fusing	$t = 10$ ms	32	A ² s
di/dt	Critical Rate of Rise of on-state Current (3)		50	A/ μ s
T_{stg} T_j	Storage and Operating Junction Temperature Range		- 40 to 110 - 40 to 110	$^\circ C$ $^\circ C$

Symbol	Parameter	TXN/TYN ..., G, K							Unit
		058	108	208	408	608	808	1008	
V_{DRM} V_{RRM}	Repetitive Peak off-state Voltage (4)	50	100	200	400	600	800	1000	V

(1) Single phase circuit, 180° conduction angle.

(2) Half sine wave.

(3) $I_G = 400$ mA $di/dt = 1$ A/ μ s.

(4) $T_j = 110^\circ C$.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction-case for D.C.	4.7	$^\circ C/W$
$R_{th(j-a)}$	Junction-ambient	60	$^\circ C/W$

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GATE CHARACTERISTICS (maximum values)

T-25-15

$P_{GM} = 20 \text{ W}$ ($t_p = 20 \mu\text{s}$)

$I_{FGM} = 2 \text{ A}$ ($t_p = 20 \mu\text{s}$)

$V_{RGM} = 5 \text{ V}$

$P_G(AV) = 0.5 \text{ W}$

$V_{FGM} = 15 \text{ V}$ ($t_p = 20 \mu\text{s}$)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
I_{GT}	$T_J = 25^\circ\text{C}$ Pulse Duration $> 20 \mu\text{s}$	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$	Without Suffix			15	mA
			Suffix G			25	
			Suffix K			40	
V_{GT}	$T_J = 25^\circ\text{C}$ Pulse Duration $> 20 \mu\text{s}$	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$				1.5	V
V_{GD}	$T_J = 110^\circ\text{C}$	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$		0.2			V
I_H	$T_J = 25^\circ\text{C}$	$I_T = 100 \text{ mA}$ Gate Open	Without Suffix			30	mA
			Suffix G			45	
			Suffix K			60	
I_L	$T_J = 25^\circ\text{C}$ Pulse Duration $> 20 \mu\text{s}$	$V_D = 12 \text{ V}$ $I_G = 80 \text{ mA}$			50		mA
V_{TM}	$T_J = 25^\circ\text{C}$	$I_{TM} = 16 \text{ A}$ $t_p = 10 \text{ ms}$				1.6	V
I_{DRM}	V_{DRM} Specified	$T_J = 25^\circ\text{C}$ $T_J = 110^\circ\text{C}$				0.01	mA
						1	
I_{RRM}	V_{RRM} Specified	$T_J = 25^\circ\text{C}$ $T_J = 110^\circ\text{C}$				0.01	mA
						1	
t_{gt}	$T_J = 25^\circ\text{C}$ $I_G = 40 \text{ mA}$	$V_D = V_{DRM}$ $di_G/dt = 0.45 \text{ A}/\mu\text{s}$	$I_T = 16 \text{ A}$		2		μs
t_q	$T_J = 110^\circ\text{C}$ $V_D = 67\% V_{DRM}$ $dv/dt = 50 \text{ V}/\mu\text{s}$	$I_T = 16 \text{ A}$ $di/dt = 30 \text{ A}/\mu\text{s}$	$V_R = 25 \text{ V}$ Gate Open		70		μs
dv/dt^*	$T_J = 110^\circ\text{C}$ Linear Slope up to $V_D = 67\% V_{DRM}$	Gate Open	Without Suffix	200			V/ μs
			Suffix G	500			
			Suffix K	750			

* For higher guaranteed values, please consult us.

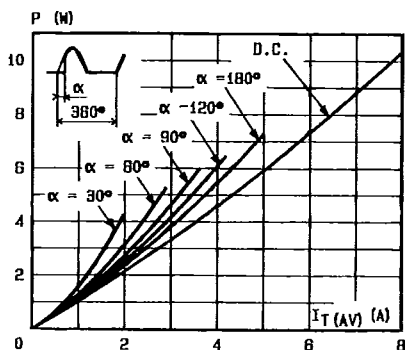


Fig.1 - Maximum mean power dissipation versus mean on-state current.

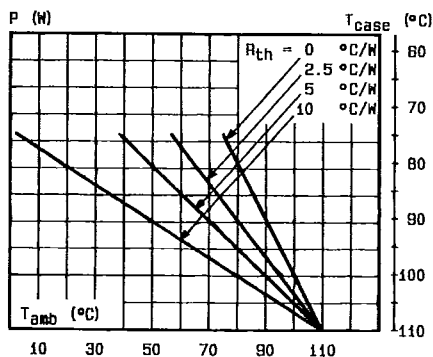


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

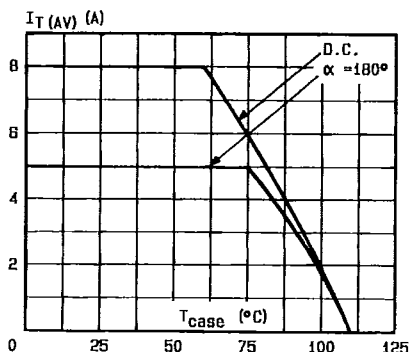


Fig.3 - Mean on-state current versus case temperature.

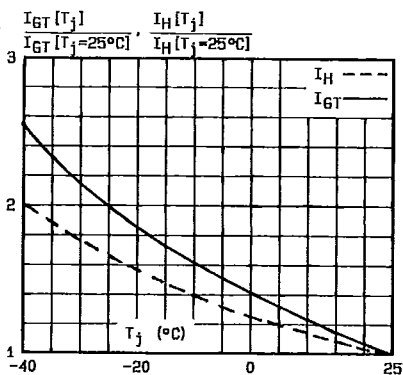


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

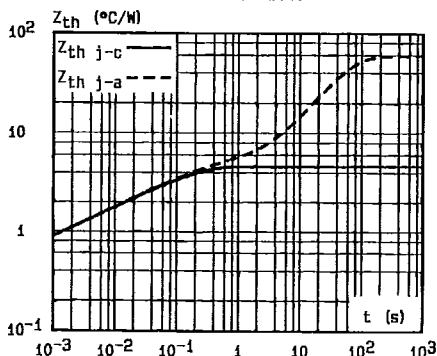


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

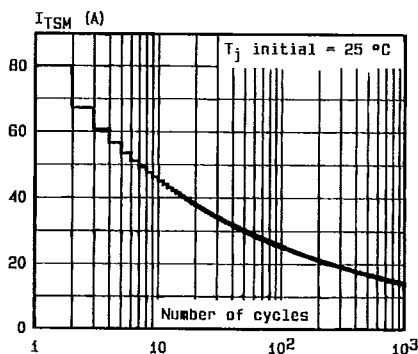


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

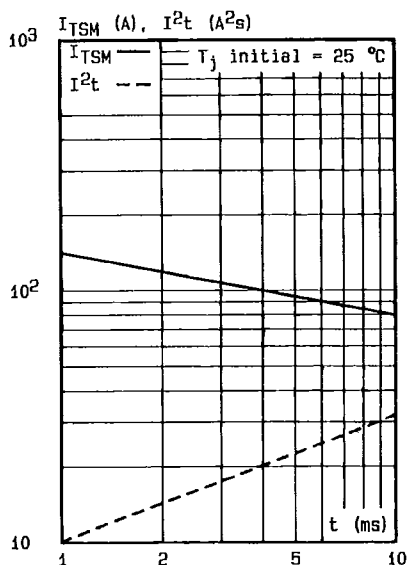


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

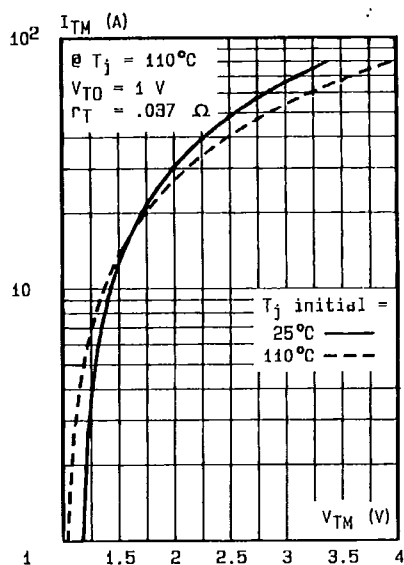
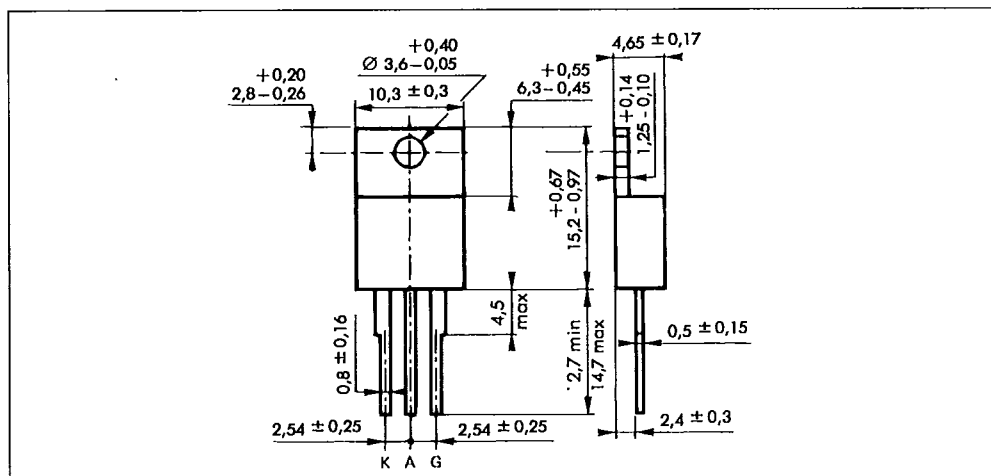


Fig.8 - On-state characteristics (maximum values).

PACKAGE MECHANICAL DATA : TO 220 AB Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g